

Preface

It is our great pleasure to present this proceedings of 2015 Spring International Conference on Material Sciences and Technology (MST-S), which is held from April 14th to April 16th, 2015 in Beijing, China. We would like to take this opportunity to thank all the authors, sponsors and participants for their support to our conference.

With the rapid development of engineering and technology, there are many new research approaches to be validated, probing questions to be asked and fresh ideas to be discussed. Following this rapid trend, SCET has done a lot of work in promoting the information exchange in advanced research and development of Engineering and Technology. And we believe, it will be stronger and stronger in providing a fascinating platform for all the researchers and scholars to share research results, to find cooperation opportunities and to improve the whole world by engineering and technology.

We appreciate the contributions from our paper reviewers and the committee members.

It is your efforts that make the conference success.

Thanks again for your attention and support to our conference.

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